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Call for Papers



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The 2019 IEEE International Conference on Mechatronics and Automation (ICMA 2019) will take place in Tianjin, China from August 4 to August 7, 2019. Tianjin is a municipality direct under the Central Government, as well as an opening city. It's situated in the eastern part of the North China Plain, covering an area of 11,917 square km and with a population of 12,930,000.

As the host city of ICMA 2019, Tianjin not only provides the attendees with a great venue for this event, but also an unparalleled experience in Chinese history through several historical architectures. You are cordially invited to join us at IEEE ICMA 2019 in Tianjin. The objective of ICMA 2019 is to provide a forum for researchers, educators, engineers, and government officials involved in the general areas of mechatronics, robotics, automation and sensors to disseminate their latest research results and exchange views on the future research directions of these fields.

The topics of interest include, but not limited to the following:

- Intelligent mechatronics, robotics, biomimetics, automation, control systems,
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- Elements, structures, mechanisms, and applications of micro and nano systems
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Contributed Papers: All papers must be submitted in PDF format prepared strictly following the IEEE PDF Requirements for Creating PDF Documents for IEEE Xplore. The standard number of pages is 6 and the maximum page limit is 8 pages with extra payment for the two extra pages. See detailed instructions in the conference web site. All papers accepted by IEEE ICMA 2019 will be indexed by EI and included in IEEE Xplore®.

Organized Sessions: Proposals with the title, the organizers, and a brief statement of purpose of the session must be submitted to an OS Chair by March 20, 2019.

Tutorials & Workshops: Proposals for tutorials and workshops that address related topics must be submitted to one of the Tutorial/Workshop Chairs by May 1, 2019.

Important Dates:

April 10, 2019 Full papers and organized session proposals
May 1, 2019 Proposals for tutorials and workshops
May 15, 2019 Notification of paper and session acceptance
June 1, 2019 Submission of final papers in IEEE PDF format

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